

INNOLUX DISPLAY CORPORATION

LCD MODULE

SPECIFICATION

Model Name: **CT018TN01**

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Customer Approval	Approved by

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Record of Revision

Version	Revise Date	Page	Content
0	05/27/03		Initial release
1	06/28/03	5/22	Correct gray scale table
		8/22	Add driver IC algorithms
		14/22	Update optical spec.
		18/22	Update quality assurance standards
		21/22	Update mechanical outline drawing
2	11/05/2003	7/22	Update Application circuit

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1. General specification

NO.	Item	Specification	Remark
1	LCD size	1.79 inch	
2	Driver element	α-Si TFT active matrix	
3	Resolution	128 X (RGB) X 160pixels	
4	Display mode	Normally white, Transmissive with LED Back-light	
5	Display number of colors	65K colors	
6	Optimal viewing direction	12 o'clock	
7	Dot pitch	0.074(W) X 0.222(V) mm	
8	Display area	28.416(W) X 35.52(V) mm	
9	Module size	34.0 X 46.7 X 3.3 mm	
10	Surface treatment	Glare Type 3H	
11	Weight	10.4g Typical	
12	Driver IC	HX8302A, HX8029A (Himax)	

2. Electrical specifications

(1). Absolute maximum ratings

Parameter		Symbol	Values		Unit	Remark
			Min.	Max.		
TFT Module	Logic Power	V _{DD}	-0.3	+4.6	V	
	DC/DC Power	V _{CI}	-0.3	+4.6	V	
Back- Light Unit	Current	I _B	-	25	mA	
Operating temperature	Top	-20	60	°C		
Storage temperature	T _{ST}	-30	70	°C		

(2). Pin assignment

(a). TFT LCD panel diving section (Connector:27-pin FPC hot bar type)

Pin no	Symbol	Function	Remark
1	NC	No Connection	-
2	GND	Power Ground	-
3	GND	Power Ground	-
4	/CS	Chip Select	Input
5	RS	Command (L) /Data (H)	Input
6	/WR	Write	Input
7	/RD	Read	Input

8	D0	Data 0	Input
9	D1	Data 1	Input
10	D2	Data 2	Input
11	D3	Data 3	Input
12	D4	Data 4	Input
13	D5	Data 5	Input
14	D6	Data 6	Input
15	D7	Data 7	Input
16	D8	Data 8	Input
17	D9	Data 9	Input
18	D10	Data 10	Input
19	D11	Data 11	Input
20	D12	Data 12	Input
21	D13	Data 13	input
22	D14	Data 14	Input
23	D15	Data 15	Input
24	/RESET	System Reset	Input
25	VCC	Logic Power	Input
26	VCI	DC/DC Converter Power	Input
27	NC	No Connection	-

(b). Backlight unit (Connector: 2-pin FPC solder type)

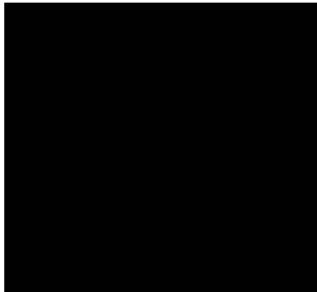
Pin no	Symbol	Function
1	Anode	LED Input Terminal
2	Cathode	GND

(3). Electrical characteristics

(a). TFT Module

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Logic Supply Power	V _{DD}	2.2	2.8	3.3	V	
DC/DC Supply Power	V _{CI}	2.5	2.8	3.3	V	
Current Consumption	Stand by	I _{SB}		0.05	mA	Note1
	Sleep	I _{SLP}		0.1	mA	Note1
	Still	I _{STL}		6	mA	Note2,4
	Full	I _F		10	mA	Note3,4
Vertical synchronous Frequency	F _{Vsync}	55	85	115	Hz	

Note:

- 1: Still Picture is internal RAM
- 2: Power supply current value is still picture
- 3: Power supply current value of moving picture is high speed write mode
- 4: Dissipation current check pattern


5: For the detail characteristics, refer to the specifications of gate/source driver

Himax: HX8609A, HX8302A

(b). Back light unit

The back-light system is an edge-lighting type with 3 white LED

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Current	I_B		15	20	mA	Note1
Power Consumption	P_{BL}		150		mW	Note2

Note:

1: 3 LEDs serial type

2: where $I_B=15\text{mA}$, $V_B=P_{BL}/I_B$

(c). Input signal, basic display colors, and gray scale of each colors

Color	Display	Data Signal																Gray Scale Level	
		RED					GREEN					BLUE							
		R0	R1	R2	R3	R4	G0	G1	G2	G3	G4	G5	B0	B1	B2	B3	B4		
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	-	
	Blue	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	-	
	Green	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	-	

	Cyan	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	-
	Red	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	-
	Magenta	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	-
Basic Color	Yellow	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	-
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	-
Gray Scale of RED	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R0
	Dark ↑	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R1
	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	R2
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	R3~R28	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		
	↓	1	0	1	1	1	0	0	0	0	0	0	0	0	0	0	R29
	Light	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	R30
	Red	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	R31
Gray Scale of GREEN	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	G0
	Dark ↑	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	G1
	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	G2
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	G3~G60	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		
	↓	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	G61
	Light	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	G62
	Green	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	G63
Gray Scale of BLUE	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	B0
	Dark ↑	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	B1
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	B2
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	B3~B28	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		
	↓	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	B29
	Light	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	B30
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	B31

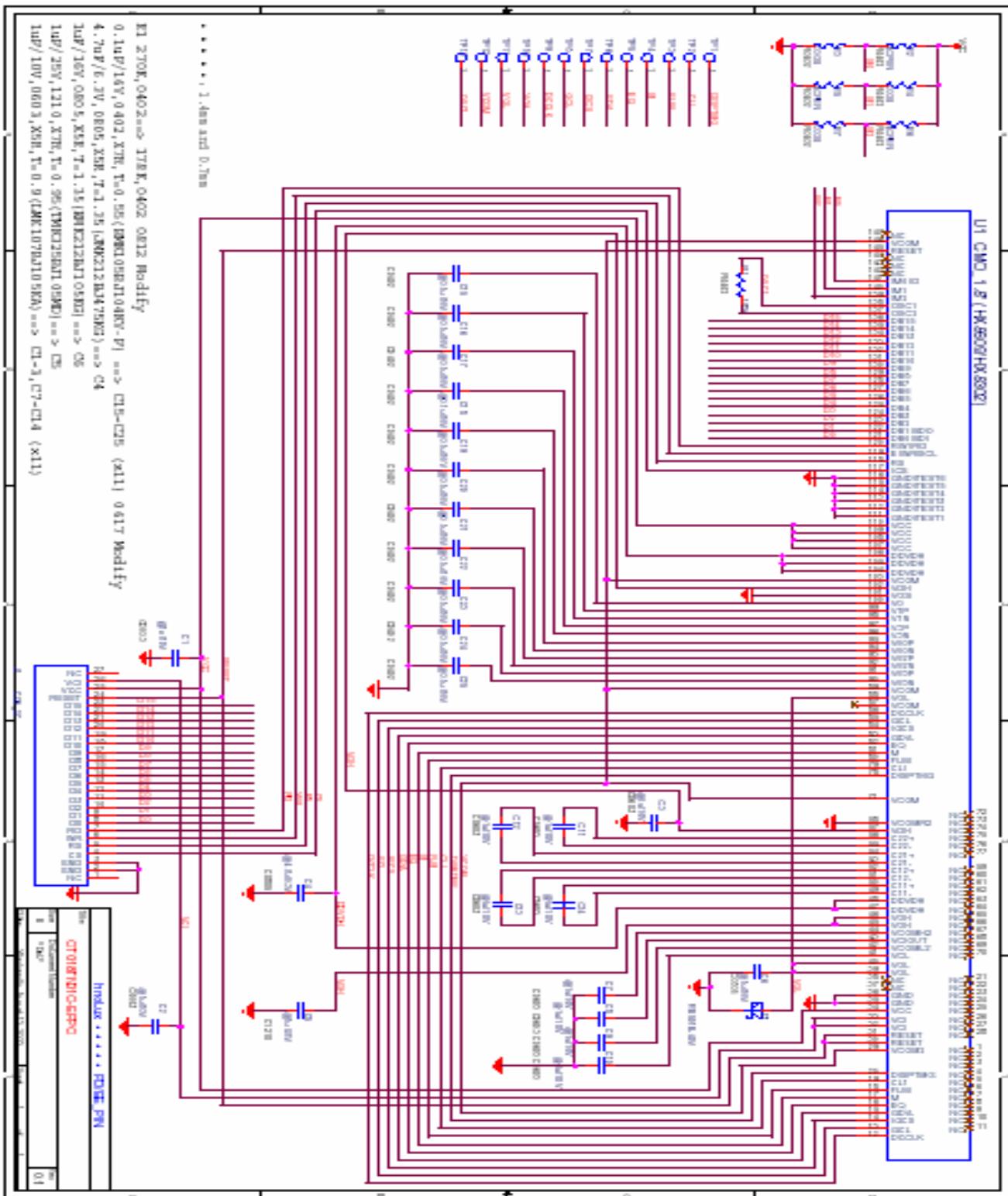
Note:

1. Definition of gray

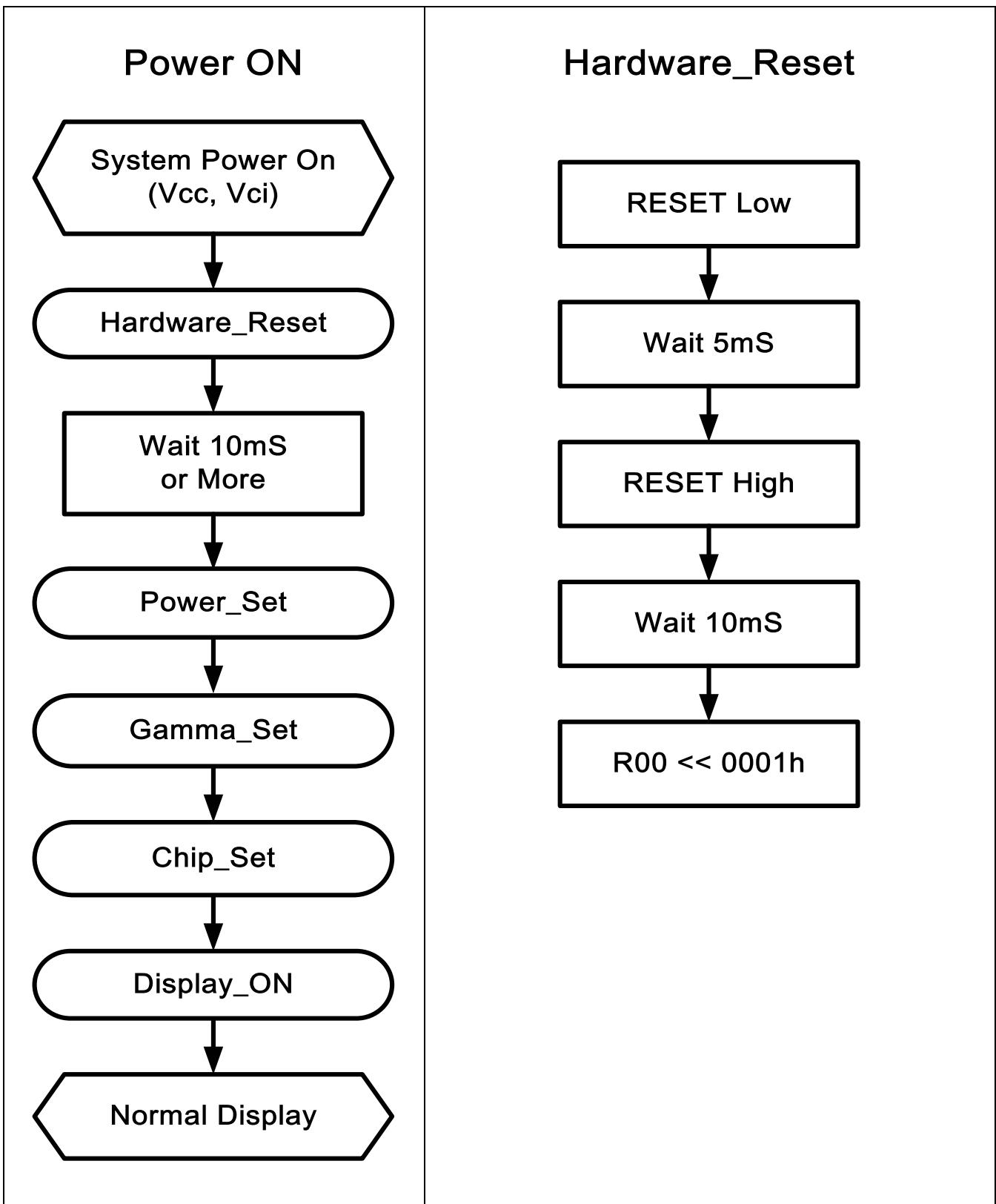
Rn=Red gray, Gn=Green gray, Bn=Blue gray, (n=gray level)

Input Signal: 0=low level voltage, 1=high level voltage

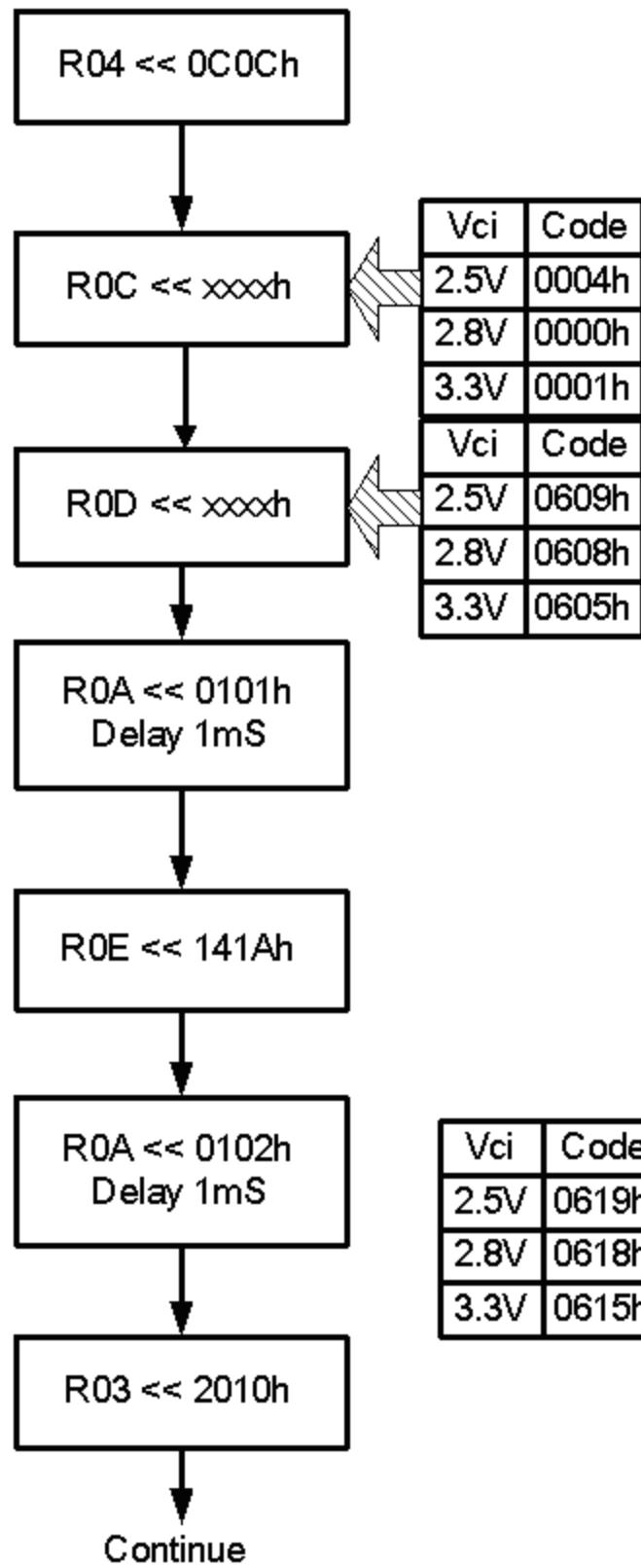
(d). Application circuit



3. Driver IC control algorithms



Power_Set



Continue

R0A << 0100h
Delay 40ms
(2 Frames or More)

R0E << 341Ah

R0A << 0102h
Delay 1mS

R0A << 0100h
Delay 40ms
(2 Frames or More)

R0D << xxxxh

R0A << 0101h
Delay 1mS

Gamma_set

```
R30 << 0604h  
R31 << 0407h  
R32 << 0107h  
R33 << 0302h  
R34 << 0006h  
R35 << 0003h  
R36 << 0301h  
R37 << 0203h  
R3F << 0000h
```

Chip_Set

```
R01 << 0113h  
R02 << 0700h  
R05 << 0230h  
R06 << 0000h  
R07 << 0700h  
R0B << 0000h  
R0F << 000Ah  
R11 << 0000h  
R14 << 9F00h  
R15 << 8050h  
R16 << 7F00h  
R17 << 9F00h  
R20 << 0000h
```

R0A << 0106h
Delay 1mS

R0A << 0107h
Delay 1mS

Display_ON

R07 << 0005h

Wait 2 Frames
or more

R07 << 0025h

R0A << 0100h
Delay 1mS

R07 << 0027h

R07 << 0037h

Normal Display

Display_OFF

R07 << 0036h

Wait 2 Frames
or more

R07 << 0026h

Wait 2 Frames
or more

R07 << 0004h

R0A << 0100h
Delay 1mS

R03 << 0000h

R0A << 0100h
Delay 1mS

Non-Display

Standby

Display OFF

R03 << 0001h

Standby
Mode

Wake Up

R00 << 0001h

R03 << 0000h

Power_Set

Display_On

Sleep

Display OFF

R03 << 0002h

R0A << 0100h
Delay 1mS

Sleep Mode

Wake Up

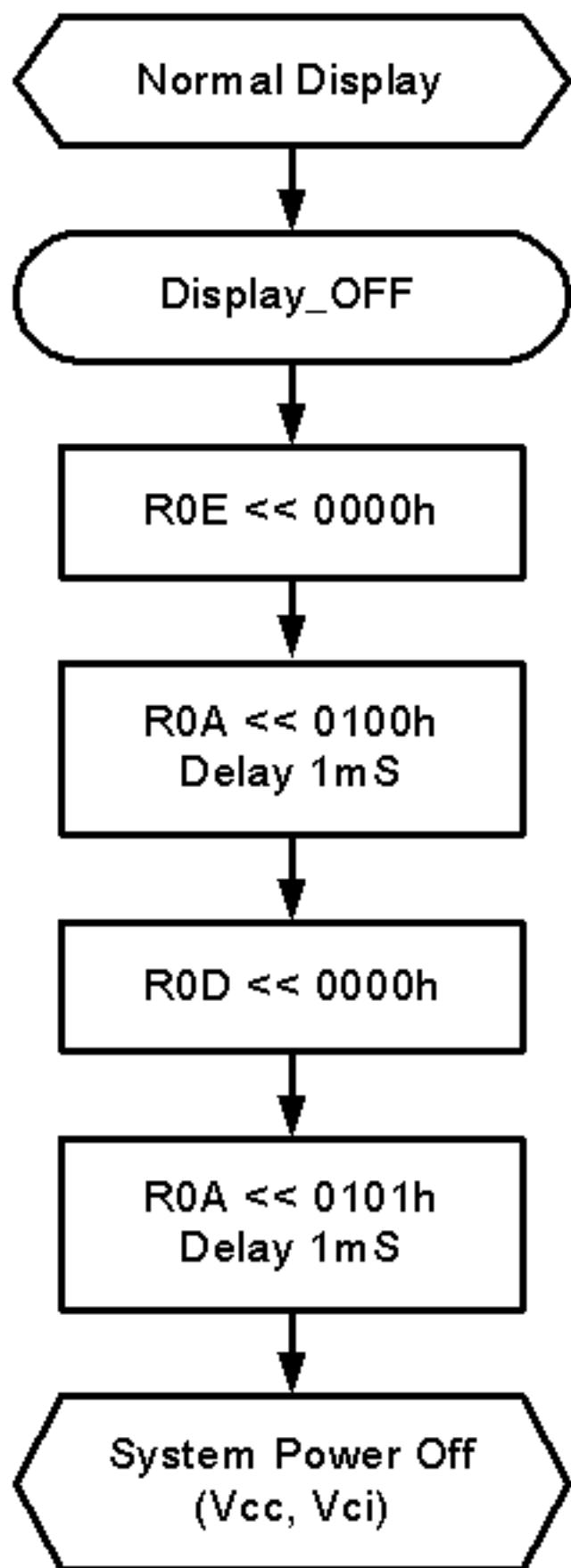
R03 << 0000h

R0A << 0100h
Delay 1mS

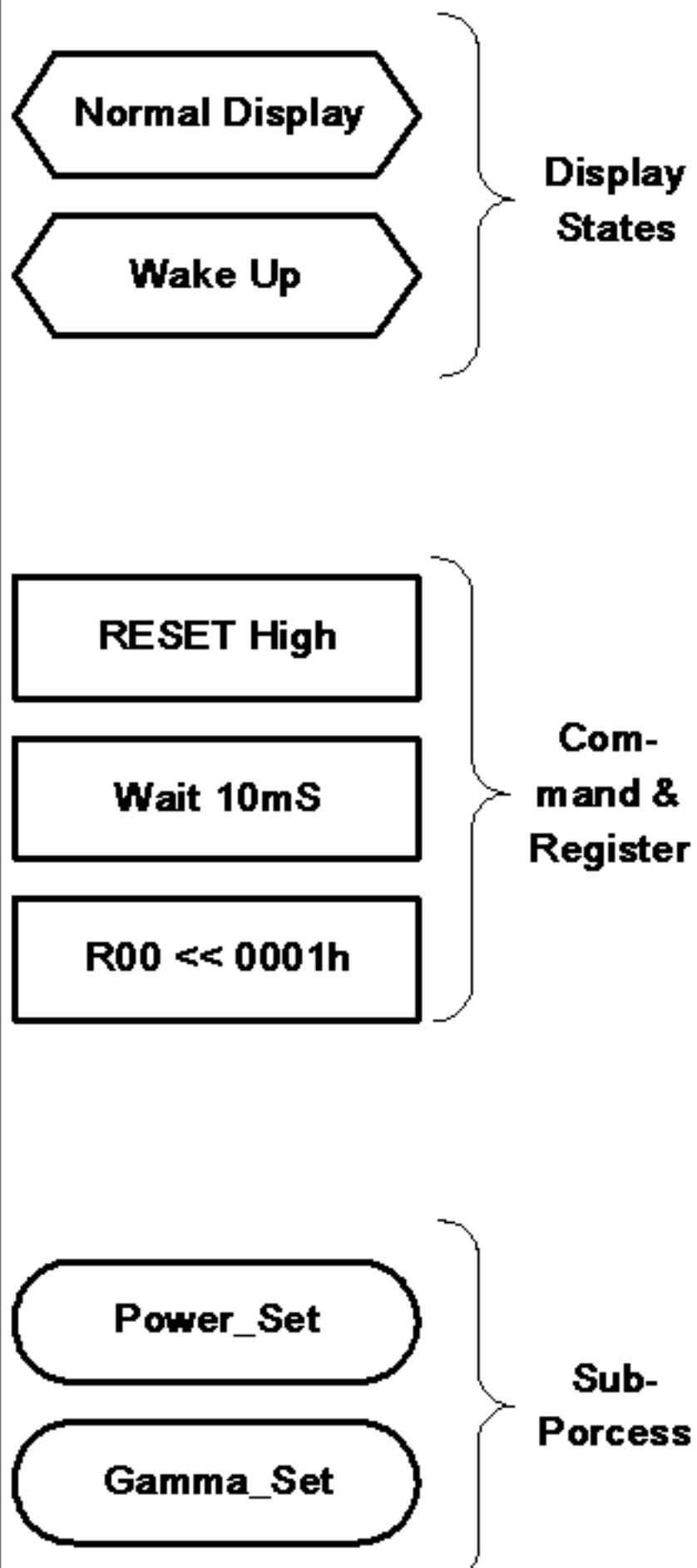
Power_Set

Display_On

Power OFF



Memo



4. Optical specifications

The following items are measured under stable conditions. The optical characteristics should be measured in dark room or equivalent state with the methods shown in Note 1.

$T_a=25\pm2^{\circ}\text{C}$, $V_{CC}=V_{CI}=2.8\text{V}$, $I_B=15\text{mA}$

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Reflectance	R	BL off	0.5	1			Note2
Contrast ratio	CR	Note 1 $\Theta=\Phi=0$ Normal Viewing Angle B/L ON	150	200			Note3
Luminance of white	Y_L		100	150		Cd/m^2	Note4
Rise+Fall Time	$(T_r)+(T_f)$			30	50	mSec	Note5
Color Chromaticity	White		0.28	0.33	0.38		
			0.30	0.35	0.40		
	Red		0.51	0.56	0.61		
			0.30	0.35	0.40		
	Green		0.31	0.36	0.41		
			0.51	0.56	0.61		
	Blue		0.10	0.15	0.20		
			0.09	0.14	0.19		
Viewing Angle	Hor.	CR≥2 B/L ON	50	TBD		Degree	Note6
			50	TBD			
	Ver.		20	TBD			
			50	TBD			

Note:

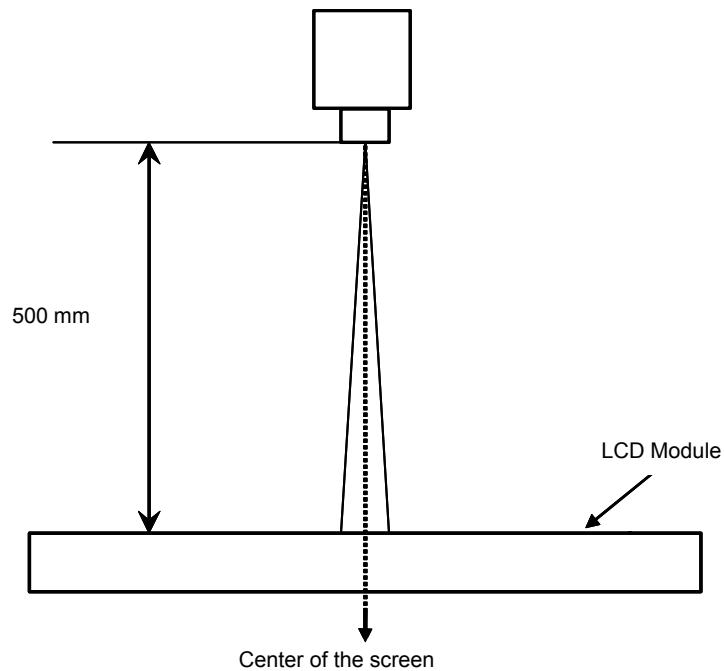
1. Test Equipment Setup

After stabilizing and leaving the panel alone at a given temperature for 30 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. 30 minutes after lighting the back-light. This should be measured in the center of screen.

-Back-Light ON Condition

Measuring Instrument : TOPCON BM-5A , BM-7

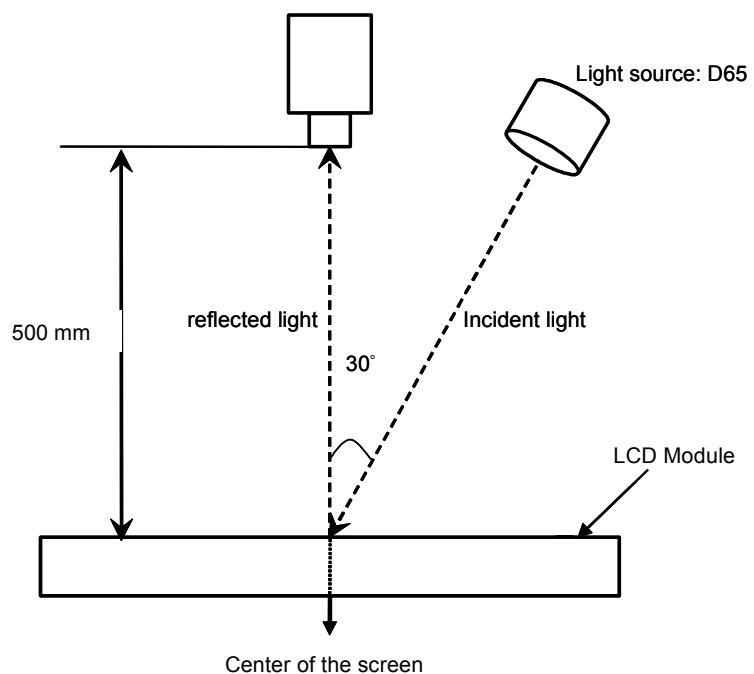
Field : 1°



-Back-Light OFF Condition

Measuring Instrument : LCD-5100

Field : 1°



2. Definition of Reflectance: the reflectance is relative quantity to the standard white BaSO₄ plate that the reflectance of the standard white plate is the 100%.

$$\text{Reflectance} = \frac{\text{Light intensity of the reflected light on LCD}}{\text{Output intensity of the reflected light on BaSO}_4\text{ plate}} \times 100\%$$

3. Definition of Contrast Ratio (CR): Ratio of gray max (Gmax) & gray min (Gmin) at the center point

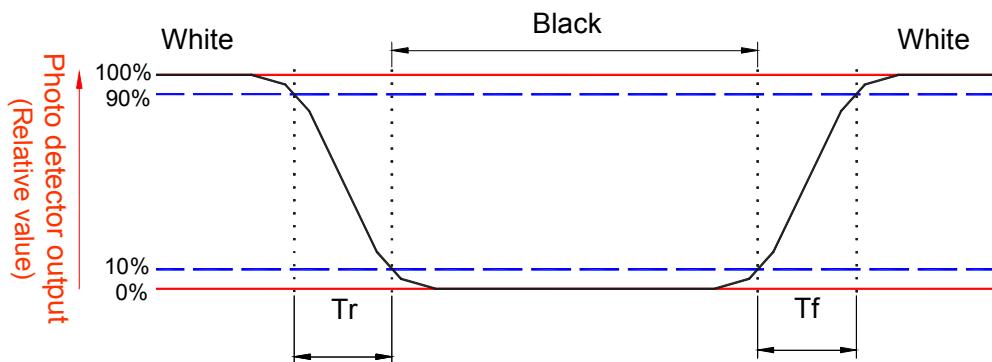
$$\text{CR} = \frac{\text{Gmax}}{\text{Gmin}}$$

Gmax: Luminance with all pixels white

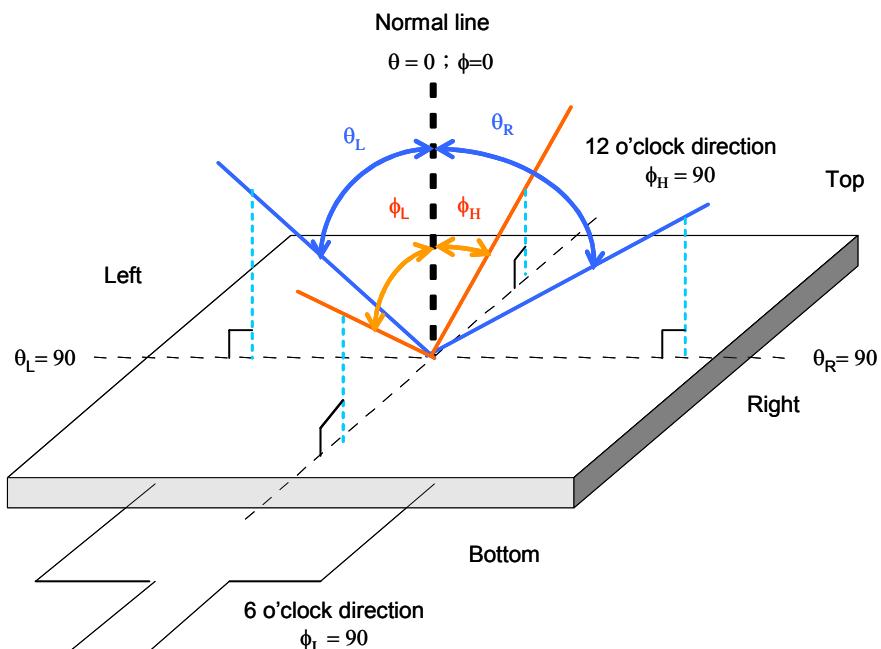
Gmin: Luminance with all pixels black

4. Definition of Luminance of white: Luminance of white at the center point

5. Definition of Response time: sum of Tr, Tf



6. Definition of Viewing Angle: Viewing angle range ($\text{CR} \geq 2$)



5. Reliability test items

Reliability levels in Mass production

Test Items	Test Conditions
High temperature storage	+70°C±3°C, Dry(30%RH max.) for 240 hours
Low temperature storage	-30°C±3°C for 240 hours
High temperature operation	+60°C±3°C, Dry(30%RH max.) for 240 hours
Low temperature operation	-20°C±3°C for 240 hours
Operation at high temperature and humidity	+40°C±3°C, 90%±3%RH max. for 240 hours
Thermal shock	-30degree/0.5h ~ +70 degree/0.5h for a total 20 cycles
Package drop	Drop onto the tilted floor from 60cm heights, 1 corner, 3 edges, 6faces. Apply shipping package to this test
Package vibration test storage	Sweep at 10Hz to 55Hz to 10Hz, amplitude 0.75mm for 20cycles each in X,Y and Z directions. Apply shipping package to this test.
Electro-static discharge	Air / Contact → ±2KV (Human body mode, contact connector, 150pF/330Ω)

Note1: High temp storage & High temp/High humidity Op the polarizer is out of subject

Note2: the test sample have recovery time 2 hours at room temp before function check

6. Quality assurance standards

(1). Sampling plan:

Unless there is other agreement , sampling plan for incoming inspection should follow MIL-STD-105E.

1.1 Lot size: Quantity per shipment as one lot (different model as different lot.)

1.2 Sampling type: Normal inspection, single sampling.

1.3 Sampling level: Level II.

1.4 AQL: Acceptable Quality Level

Major defect: AQL=0.65%

Minor defect: AQL=1.0%.

(2). Panel inspection condition:

2.1 Environment:

Room Temperature: 25 ± 5 . °C

Humidity: $65 \pm 5\%$ RH.

Illumination: 300 ~ 700 Lux.

2.2 Inspection Distance: 35 ± 5 cm

2.3 Inspection Angle: the vision of inspector should be perpendicular to the surface of the module.

(3). Display quality

3.1 Function Related: the function defects such as line defect, abnormal display, no display are considered the major defects.

3.2 Bright/dark dots

<u>Defect Type</u>	<u>Specification</u>	<u>Major</u>	<u>Minor</u>
Bright Dots	$N \leq 2$		●
Dark Dots	$N \leq 4$		●
Total Bright and Dark Dots	$N \leq 5$		●
Distance between Bright and Bright dot	$L \geq 15$ mm		●
Distance between Bright and Dark dot	$L \geq 5$ mm		●
Distance between Dark dot	$L \geq 5$ mm		●

Note 1: Dot defect is defined as the defective area is larger than 50% of the dot area.

Bright Dot is defined 5% transmission ND filter.

Note 2: Light Leakage: There shall not be visible light around the customer's bezel after assembly in normal View angle.

3.3 Pixel definition

R	G	B	R	G	B	R	G	B				Dot Defective
R	G	B	R	G	B	R	G	B				Defective Pixel
R	G	B	R	G	B	R	G	B				Defective Adjacent Sub-Pixels
												Defective Adjacent Pixels

Note: In cases where partial sub-pixel or pixel defects exceed 50% of the affected sub-pixel or pixel area, it will be counted as 1 defect.

3.4 Visual Inspection specification

<u>Defect Type</u>	<u>Specification Size</u>	<u>Count(N)</u>	<u>Major</u>	<u>Minor</u>
Dot Shape (Particle、Scratch and Bubbles in display area)	D ≤ 0.25 mm	Ignored	●	●
	0.25mm < D ≤ 0.5mm	N ≤ 3		
	D > 0.5mm	N=0		
Line Shape (Particles、Scratch、Lint and Bubbles in display area)	W ≤ 0.1 mm	Ignored	●	●
	0.1 < W ≤ 0.5mm and L ≤ 3mm	N ≤ 3		
	W > 0.5mm or L > 3mm (Lint)	N=0		
	0.1 < W ≤ 0.5mm and L ≤ 10mm	N ≤ 3		
	W > 0.1 L > 10 mm	N=0		
Bubble in cell (active area)	It should be found by eyes			●
Bezel	Scratch	No harm	●	●
	Dirt			
	Wrap	No harm		
	Sunken	No harm		
Label	No label	No	●	●
	Invert label			
	Broken			
	Dirt	Word can be read.		●
	Not clear		●	●
	Word out of shape			
	Mistake	No		●
	Position	Be attached on right position		●
	Not enough	No		
	Limp	No		
Connector	Connection status	No bend on pins and damage		
FPC/FFC	Broken	No		

Note:

Extraneous substance and scratch do not affect the display of image, for instance , the extraneous substance under polarizer film but outside the display area, scratch on metal bezel and backlight module or polarizer film. Outside of the display area are not counted.

7. Handling Precautions

1 Safety

The liquid crystal in the LCD is poisonous. **DO NOT** put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

2 Handling

- 1) The LCD panel is plate glass. **DO NOT** subject the panel to mechanical shock or to excessive force on its surface.
- 2) The polarizer attached to the display is very easy to damage, handle it with careful attention.
- 3) To avoid contamination on the display surface, **DO NOT** touch the display surface with bare hands.
- 4) Provide a space so that the LCD panel does not come into contact with other components.
- 5) To protect the LCD panel from external pressure, put covering glass (acrylic board or similar board) keeping appropriate gap between them.
- 6) Transparent electrodes may be disconnected if you use the LCD panel under environmental conditions where dew condensation occurs.
- 7) Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in malfunctioning of the ICs.
- 8) To prevent such malfunctioning of the ICs, your design and mounting layout done are so that the IC is not exposed to light in actual use.

3 Static electricity

- 1) Ground soldering iron tips, tools and testers when you operate.
- 2) Ground your body when handling the products.
- 3) **DO NOT** apply voltage to the input terminal without applying power supply.
- 4) **DO NOT** apply voltage which exceeds the absolute maximum rating.
- 5) Store the products in an anti-electrostatic container.

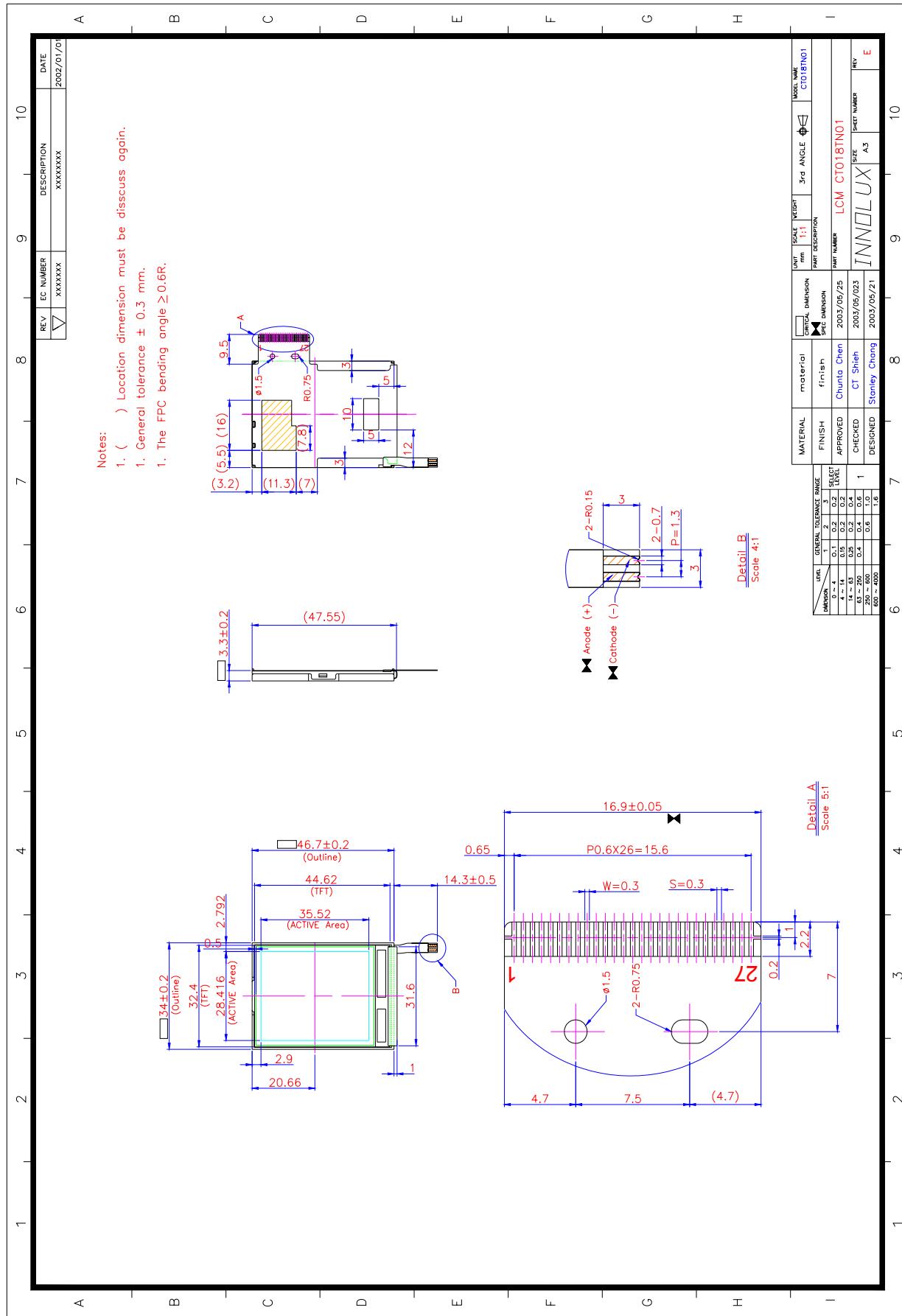
4 Storage

- 1) Store the products in a dark place at $+25^{\circ}\text{C} \pm 10^{\circ}\text{C}$, low humidity (65%RH or less).
- 2) **DO NOT** store the products in an atmosphere containing organic solvents or corrosive gases.

5 Cleaning

- 1) **DO NOT** wipe the polarizer with dry cloth, as it might cause scratch.
- 2) Wipe the polarizer with a soft cloth soaked with petroleum IPA, other chemical might damage.

8. Mechanical dimensions



9. Package drawing

